



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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CMPD6001
 CMPD6001A
 CMPD6001C
 CMPD6001S

**SURFACE MOUNT SILICON
 ULTRA LOW LEAKAGE
 SWITCHING DIODES**



www.centrasemi.com



SOT-23 CASE

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPD6001 series devices are silicon switching diodes manufactured by the epitaxial planar process, designed for switching applications requiring an extremely low leakage diode.

The following configurations are available:

CMPD6001 SINGLE
 CMPD6001A DUAL, COMMON ANODE
 CMPD6001C DUAL, COMMON CATHODE
 CMPD6001S DUAL, IN SERIES

MARKING CODE: ULO

MARKING CODE: ULA

MARKING CODE: ULC

MARKING CODE: ULS

MAXIMUM RATINGS: ($T_A=25^\circ\text{C}$)

Continuous Reverse Voltage
 Peak Repetitive Reverse Voltage
 Continuous Forward Current
 Peak Repetitive Forward Current
 Peak Forward Surge Current, $t_p=1.0\mu\text{s}$
 Peak Forward Surge Current, $t_p=1.0\text{s}$
 Power Dissipation
 Operating and Storage Junction Temperature
 Thermal Resistance

SYMBOL		UNITS
V_R	75	V
V_{RRM}	100	V
I_F	250	mA
I_{FRM}	250	mA
I_{FSM}	4.0	A
I_{FSM}	1.0	A
P_D	350	mW
T_J, T_{stg}	-65 to +150	$^\circ\text{C}$
θ_{JA}	357	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS PER DIODE: ($T_A=25^\circ\text{C}$ unless otherwise noted)

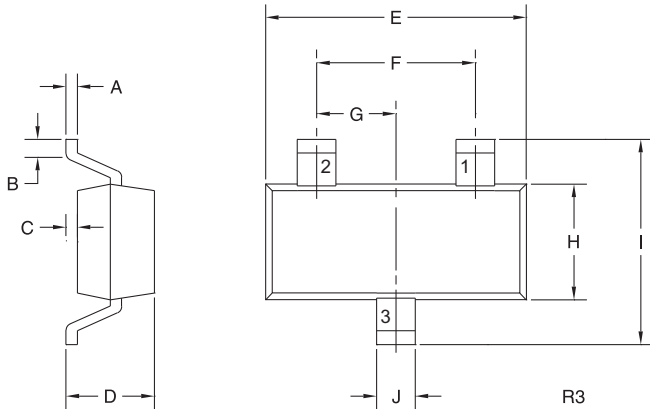
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I_R	$V_R=75\text{V}$		500	pA
BV_R	$I_R=100\mu\text{A}$	100		V
V_F	$I_F=1.0\text{mA}$		0.85	V
V_F	$I_F=10\text{mA}$		0.95	V
V_F	$I_F=100\text{mA}$		1.1	V
C_J	$V_R=0, f=1.0\text{MHz}$		2.0	pF
t_{rr}	$I_R=I_F=10\text{mA}, I_{rr}=1.0\text{mA}, R_L=100\Omega$		3.0	μs

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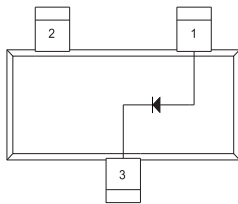
SOT-23 CASE - MECHANICAL OUTLINE



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.003	0.007	0.08	0.18
B	0.006	-	0.15	-
C	-	0.005	-	0.13
D	0.035	0.043	0.89	1.09
E	0.110	0.120	2.80	3.05
F	0.075		1.90	
G	0.037		0.95	
H	0.047	0.055	1.19	1.40
I	0.083	0.098	2.10	2.49
J	0.014	0.020	0.35	0.50

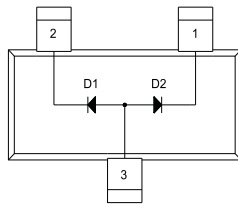
SOT-23 (REV: R3)

PIN CONFIGURATIONS



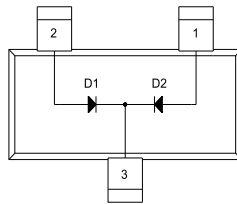
CMPD6001
LEAD CODE:
 1) Anode
 2) No Connection
 3) Cathode

MARKING CODE: ULO



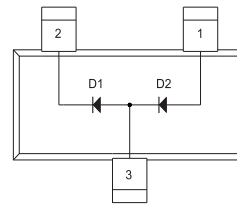
CMPD6001A
LEAD CODE:
 1) Cathode D2
 2) Cathode D1
 3) Anode D1, D2

MARKING CODE: ULA



CMPD6001C
LEAD CODE:
 1) Anode D2
 2) Anode D1
 3) Cathode D1, D2

MARKING CODE: ULC



CMPD6001S
LEAD CODE:
 1) Anode D2
 2) Cathode D1
 3) Anode D1, Cathode D2

MARKING CODE: ULS

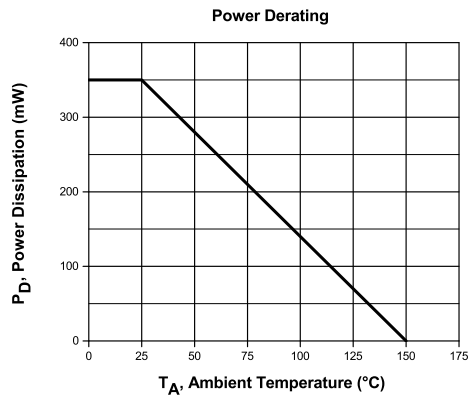
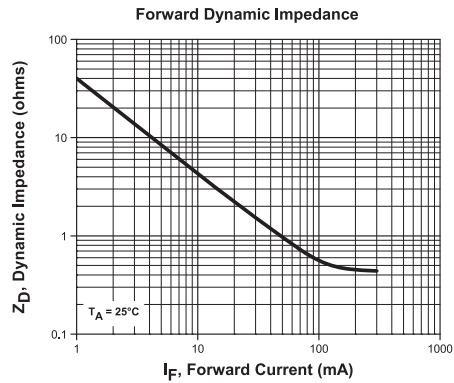
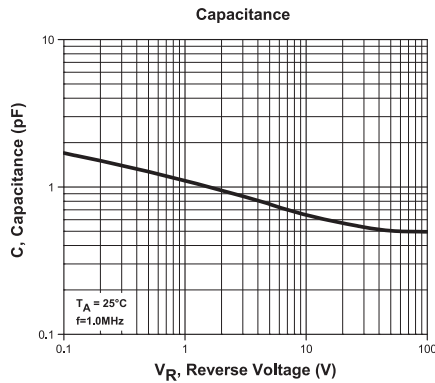
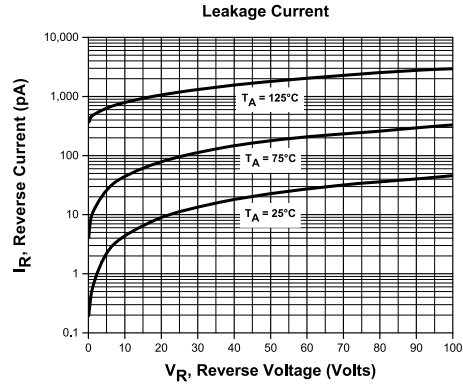
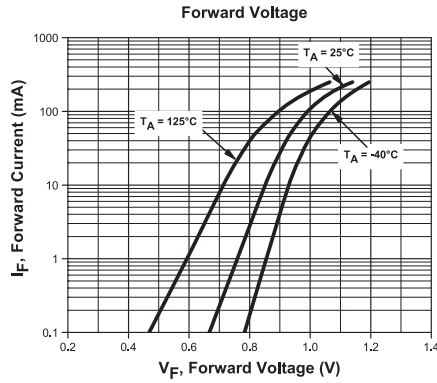
R6 (16-February 2017)

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TYPICAL ELECTRICAL CHARACTERISTICS



R6 (16-February 2017)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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